

General Description

This IGBT is produced using advanced Magnachip's Field Stop Trench IGBT Technology, which provides high performance, excellent quality and high ruggedness.

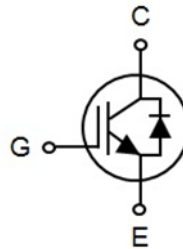
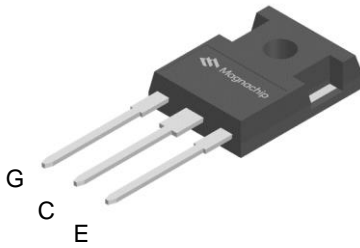
Features

- High ruggedness for motor control
- $V_{CE(sat)}$ positive temperature coefficient
- Very soft, fast recovery anti-parallel diode
- Low EMI
- Maximum junction temperature 175°C

Applications

- PV Inverter
- UPS Power
- Welder

TO-247



G : Gate
C : Collector
E : Emitter

Maximum Ratings

Parameter	Symbol	Rating	Unit
Collector-emitter voltage	V_{CE}	650	V
DC collector current, limited by T_{vjmax}	I_C	$T_C=25^\circ C$	100
		$T_C=100^\circ C$	75
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpuls}	225	A
Diode forward current, limited by T_{vjmax}	I_F	$T_C=25^\circ C$	80
		$T_C=100^\circ C$	50
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpuls}	225	A
Gate-emitter voltage	V_{GE}	± 20	V
Power dissipation	P_D	$T_C=25^\circ C$	428
		$T_C=100^\circ C$	214
Short circuit withstand time $V_{CC} \leq 360V, V_{GE} = 15V, T_{vj} = 150^\circ C$	t_{sc}	5	μs
Operating Junction temperature range	T_{vj}	-40~175	$^\circ C$
Storage temperature range	T_{stg}	-55~150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Rating	Unit
Thermal resistance junction-to-ambient	$R_{th(j-a)}$	40	$^\circ C/W$
Thermal resistance junction-to-case for IGBT	$R_{th(j-c)}$	0.35	
Thermal resistance junction-to-case for Diode	$R_{th(j-c)}$	0.70	

Ordering Information

Part Number	Marking	Temp. Range	Package	Packing	RoHS Status
MBQ75T65PEH	75T65PEH	-55~175°C	TO-247	Tube	Halogen Free

Electrical Characteristics (T_{vj} = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit	
Static Characteristics							
Collector-emitter breakdown voltage	BV _{CES}	I _C = 2mA, V _{GE} = 0V	650	-	-	V	
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 75A, V _{GE} = 15V	T _{vj} = 25°C	-	1.7	2	V
			T _{vj} = 175°C	-	2.2	-	
Diode forward voltage	V _F	V _{GE} = 0V, I _F = 50A	T _{vj} = 25°C	-	1.55	1.8	V
			T _{vj} = 175°C	-	1.6	-	
Gate-emitter threshold voltage	V _{GE(th)}	V _{CE} = V _{GE} , I _C = 1.2mA	4.5	5.5	6.5	V	
Zero gate voltage collector current	I _{CES}	V _{CE} = 650V, V _{GE} = 0V, T _{vj} = 25°C	-	-	20	μA	
Gate-emitter leakage current	I _{GES}	V _{GE} = 20V, V _{CE} = 0V	-	-	±100	nA	
Dynamic Characteristics							
Total gate charge	Q _G	V _{CE} = 520V, I _C = 75A, V _{GE} = 15V	-	280	-	nC	
Gate-emitter charge	Q _{GE}		-	42	-		
Gate-collector charge	Q _{GC}		-	114	-		
Input capacitance	C _{ies}	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz	-	6900	-	pF	
Output capacitance	C _{oes}		-	230	-		
Reverse transfer capacitance	C _{res}		-	158	-		
Switching Characteristics							
Turn-on delay time	t _{d(on)}	V _{GE} = -5/15V, V _{CC} = 400V, I _C = 75A, R _G = 10Ω, Inductive Load, T _{vj} = 25°C	-	38	-	ns	
Rise time	t _r		-	192	-		
Turn-off delay time	t _{d(off)}		-	156	-		
Fall time	t _f		-	103	-	mJ	
Turn-on switching energy	E _{on}		-	4.69	-		
Turn-off switching energy	E _{off}		-	1.75	-		
Total switching energy	E _{ts}	-	6.44	-			
Turn-on delay time	t _{d(on)}	V _{GE} = -5/15V, V _{CC} = 400V, I _C = 75A, R _G = 10Ω, Inductive Load, T _{vj} = 175°C	-	37	-	ns	
Rise time	t _r		-	194	-		
Turn-off delay time	t _{d(off)}		-	168	-		
Fall time	t _f		-	106	-	mJ	
Turn-on switching energy	E _{on}		-	5.62	-		
Turn-off switching energy	E _{off}		-	2.04	-		
Total switching energy	E _{ts}	-	7.66	-			
Reverse recovery time	t _{rr}	I _F = 50A, di _F /dt = 200A/μs, T _{vj} = 25°C	-	181	-	ns	
Reverse recovery current	I _{rr}		-	10.4	-	A	
Reverse recovery charge	Q _{rr}		-	1.12	-	μC	
Reverse recovery time	t _{rr}	I _F = 50A, di _F /dt = 200A/μs, T _{vj} = 175°C	-	384	-	ns	
Reverse recovery current	I _{rr}		-	13.3	-	A	
Reverse recovery charge	Q _{rr}		-	3.07	-	μC	

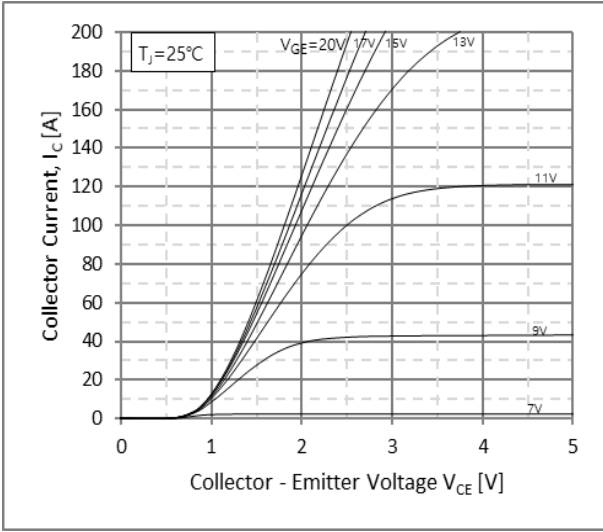


Fig.1 Typical Output Characteristics ($T_J = 25^\circ\text{C}$)

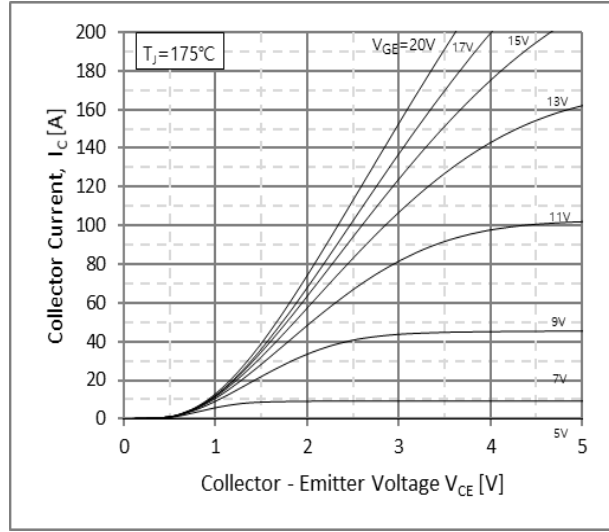


Fig.2 Typical Output Characteristics ($T_J = 175^\circ\text{C}$)

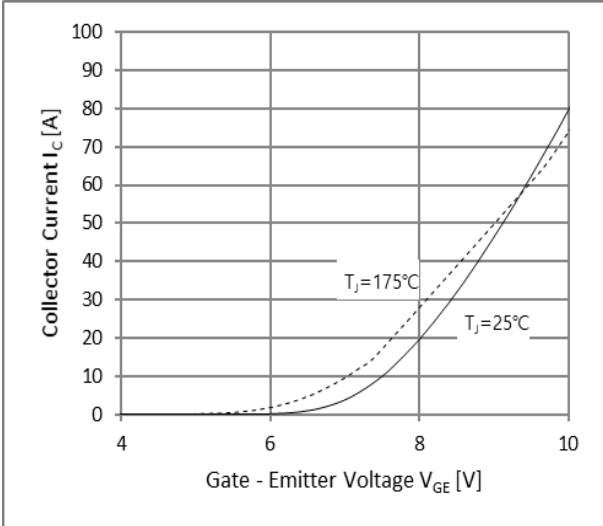


Fig.3 Typical Transfer Characteristics

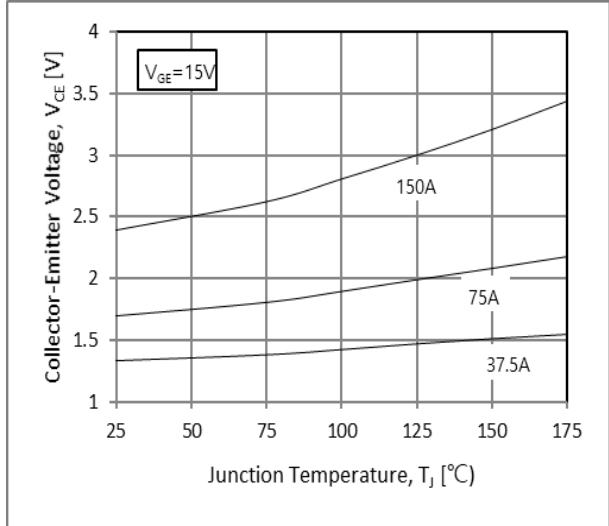


Fig.4 Typical Collector-Emmitter Saturation Voltage - Junction Temperature

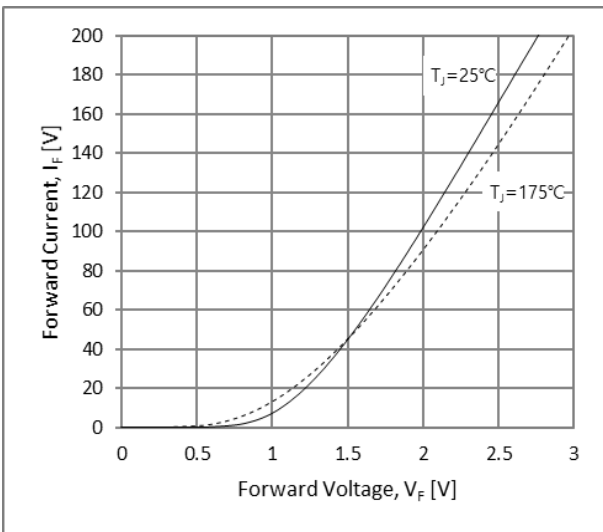


Fig.5 Diode Forward Characteristics

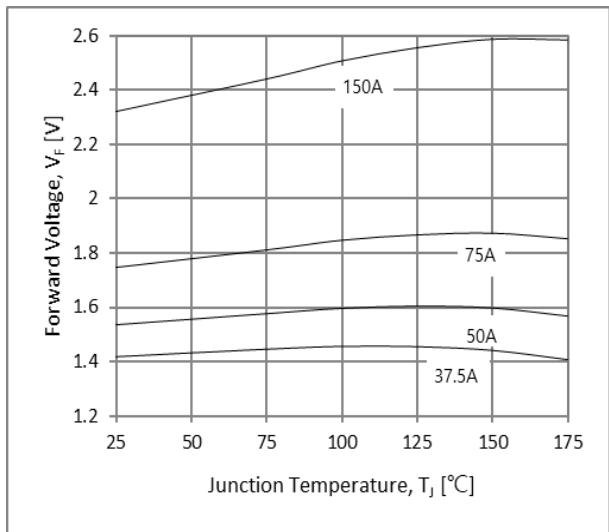


Fig.6 Diode Forward-Junction Temperature

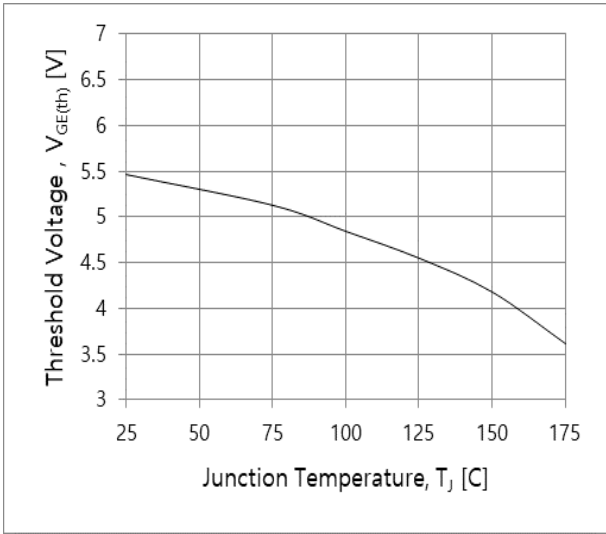


Fig.7 Threshold Voltage-Junction Temperature

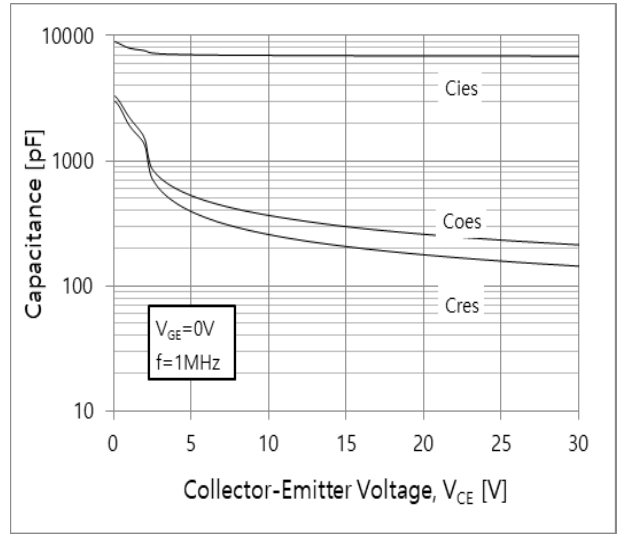


Fig.8 Typical Capacitance

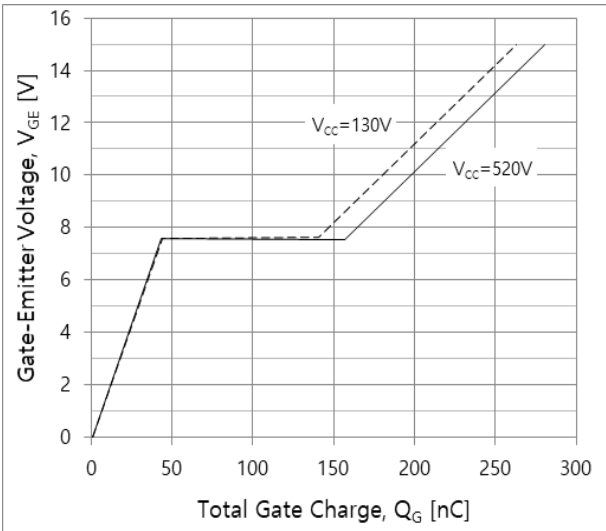


Fig.9 Typical Gate Charge

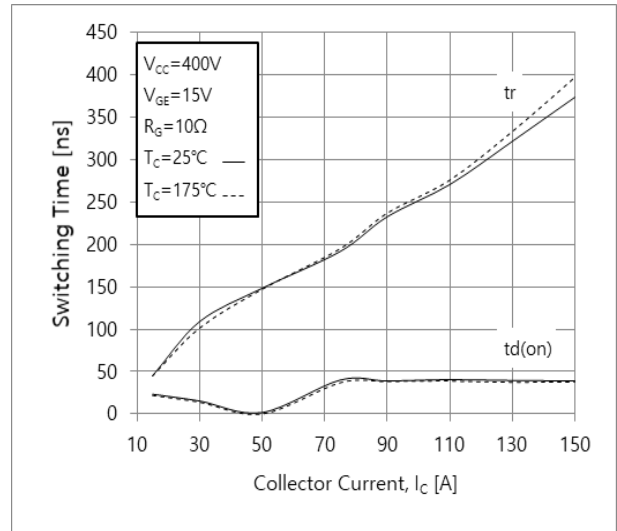


Fig.10 Typical Turn on-Collector Current

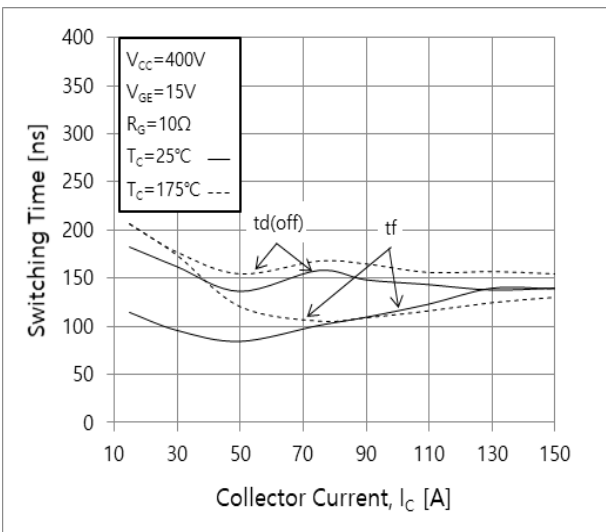


Fig.11 Typical Turn off-Collector Current

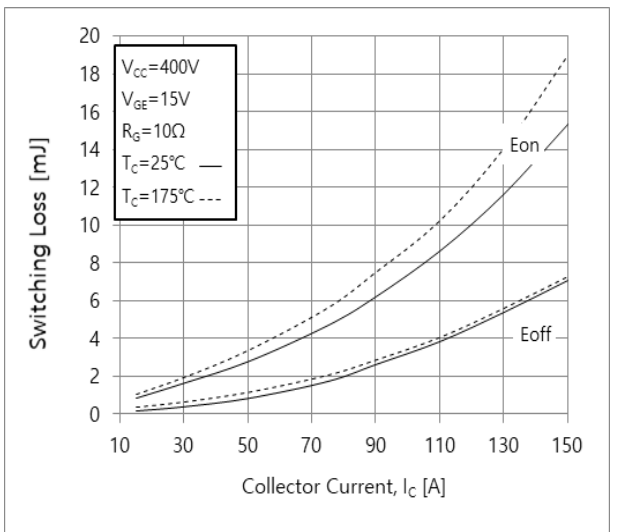


Fig.12 Switching Loss-Collector Current

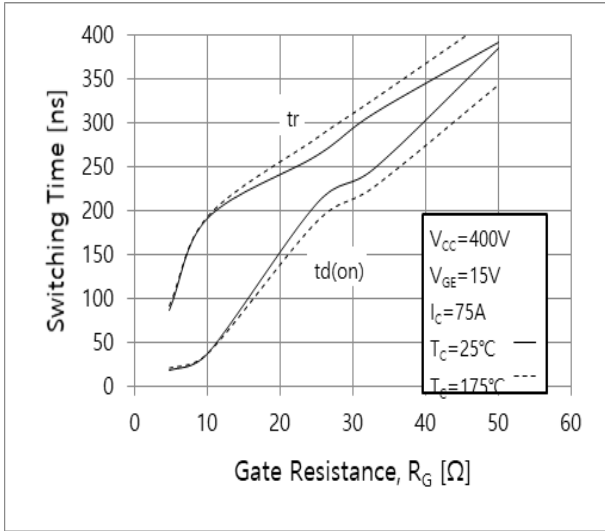


Fig.13 Turn on Characteristics-Gate Resistance

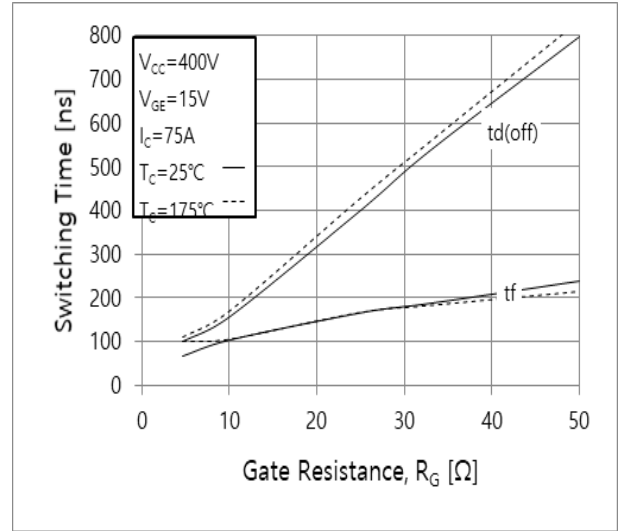


Fig.14 Turn off Characteristics-Gate Resistance

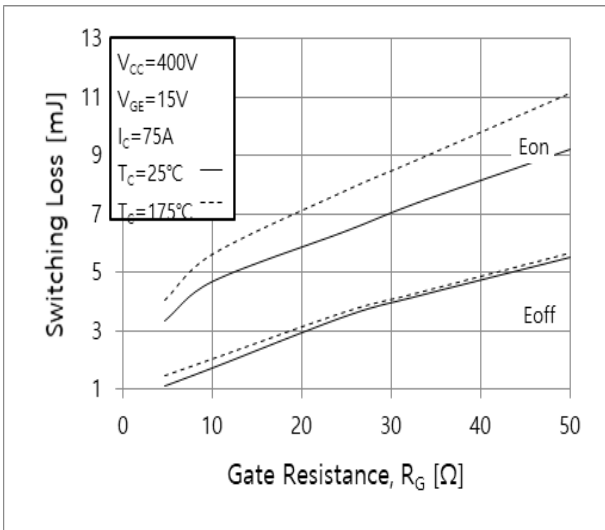


Fig.15 Switching Loss-Gate Resistance

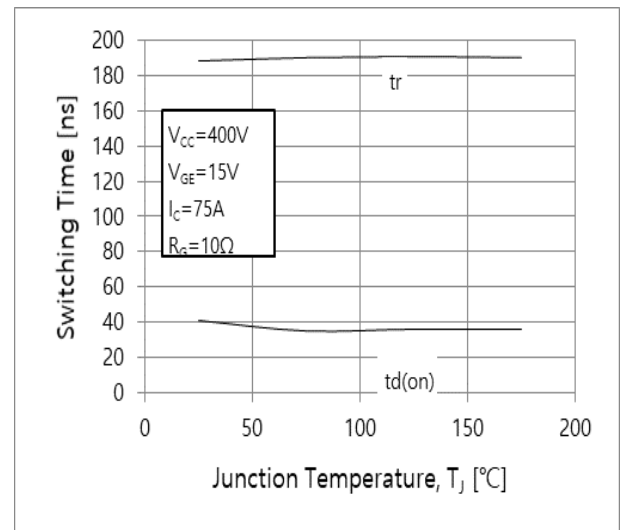


Fig.16 Turn on Characteristics-Junction Temperature

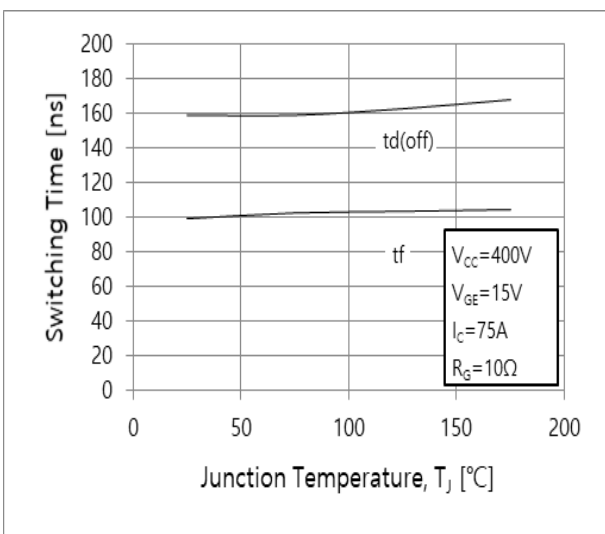


Fig.17 Turn off Characteristics

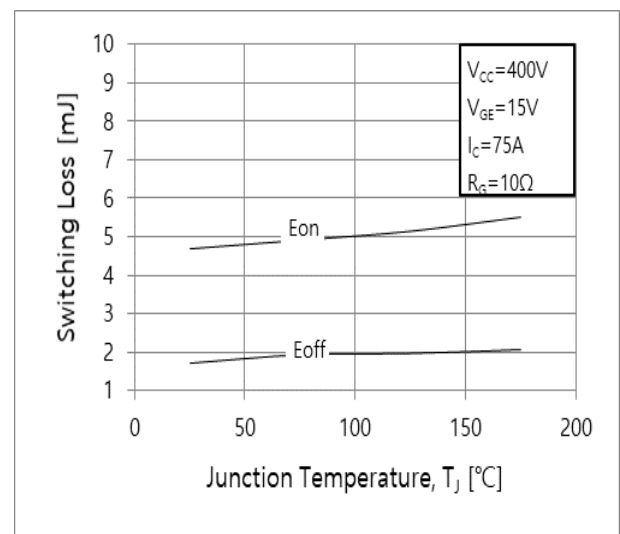


Fig.18 Switching Loss-Junction Temperature

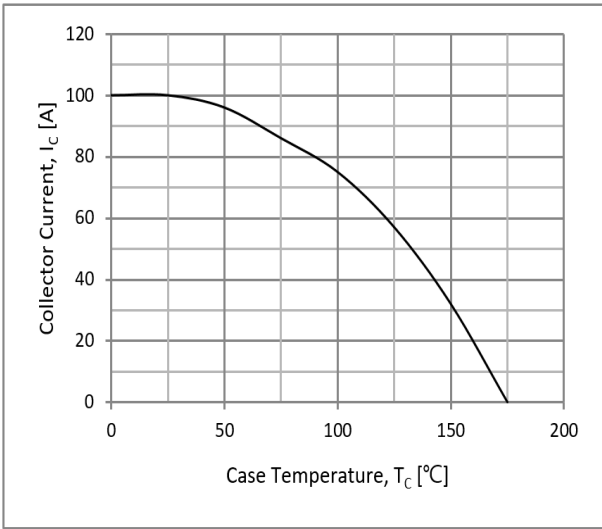


Fig.19 Case Temperature-Collector Current

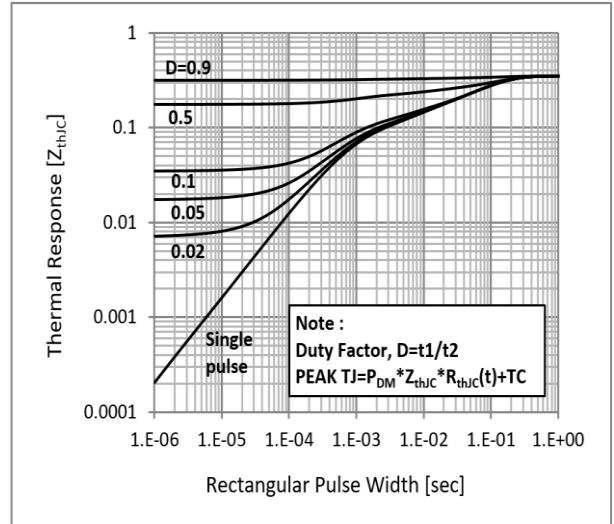


Fig.20 IGBT Transient Thermal Impedance

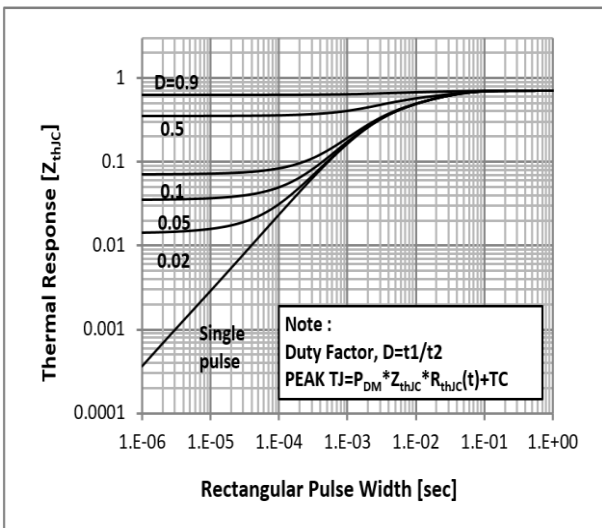


Fig.21 FRD Transient Thermal Impedance

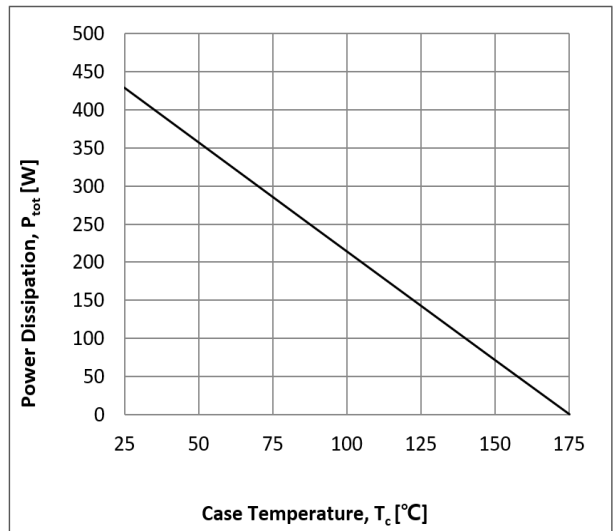
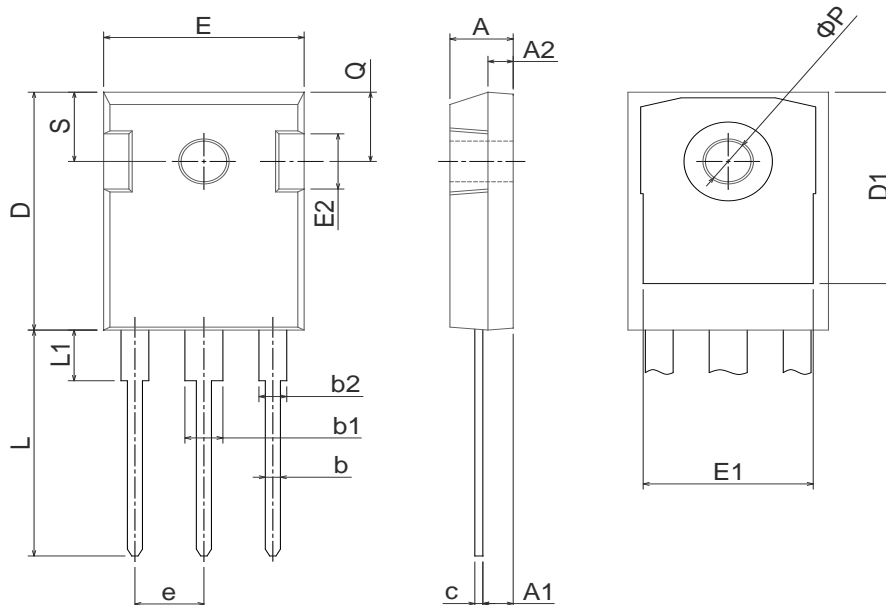


Fig.22 Power Dissipation-Case Temperature

Physical Dimension

TO-247

Dimensions are in millimeters, unless otherwise specified




Dimension	Min(mm)	Max(mm)
A	4.70	5.31
A1	2.20	2.60
A2	1.50	2.49
b	0.99	1.40
b1	2.59	3.43
b2	1.65	2.39
c	0.38	0.89
D	20.30	21.46
D1	13.08	-
E	15.45	16.26
E1	13.06	14.02
E2	4.32	5.49
e	5.45BSC	
L	19.81	20.57
L1	-	4.50
ΦP	3.50	3.70
Q	5.38	6.20
S	6.15BSC	

Note : Package body size, length and width do not include mold flash, protrusions and gate burrs.

DISCLAIMER:

The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.

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